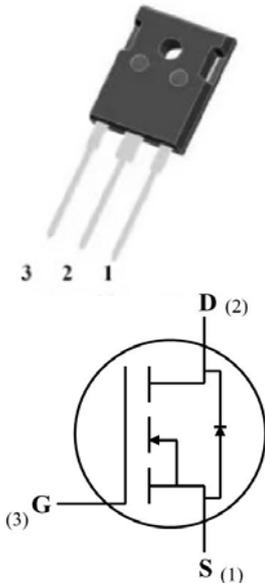


## Silicon Carbide Power MOSFET (N-Channel Enhancement)

$V_{DS}$	1200V
$I_D$ (25°C)	24A
$R_{DS(on)}$	115mΩ



### Features

- High speed switching
- Essentially no switching losses
- Reduction of heat sink requirements
- Maximum working temperature at 175 °C
- High blocking voltage
- Fast Intrinsic diode with low recovery current
- High-frequency operation
- Halogen free, RoHS compliant

### Typical Applications

Typical applications are in power factor correction(PFC), solar inverter, uninterruptible power supply, motor drives, photovoltaic inverter, electric car and charger.

### Mechanical Data

- **Package:** TO-247AB
- **Terminals:** Tin plated leads
- **Polarity:** As marked

### ■ Maximum Ratings ( $T_c=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	VALUE	TEST CONDITIONS	NOTE
Device marking code			D2120120NCTYG3		
Drain source voltage @ $T_j=25^\circ\text{C}$	$V_{DS,max}$	V	1200	$V_{GS}=0V, I_D=100\mu\text{A}$	
Gate source voltage @ $T_j=25^\circ\text{C}$	$V_{GS,max}$	V	-8/+22	Absolute maximum values (AC f > 1Hz, duty cycle < 1%)	
Gate source voltage @ $T_j=25^\circ\text{C}$	$V_{GS,op}$	V	-5/+18	Recommended operational values	
Continuous drain current @ $T_c=25^\circ\text{C}$	$I_D$	A	24	$V_{GS}=18V, T_c=25^\circ\text{C}$	Fig.17
Continuous drain current @ $T_c=100^\circ\text{C}$			16	$V_{GS}=18V, T_c=100^\circ\text{C}$	
Pulsed drain current	$I_{D(pulsed)}$	A	57	Pulse width $t_p$ limited by $T_{j,max}$	Fig.22
Avalanche energy, Single pulse	$E_{AS}$	mJ	230	$V_{DD}=75V, L=30mH$	
Power Dissipation	$P_{TOT}$	W	125	$T_c=25^\circ\text{C}, T_j = 175^\circ\text{C}$	Fig.16
Power Dissipation			62	$T_c=100^\circ\text{C}, T_j = 175^\circ\text{C}$	
Operating junction and Storage temperature range	$T_j, T_{stg}$	$^\circ\text{C}$	-55 to +175		
Soldering temperature	$T_L$	$^\circ\text{C}$	260	1.6mm (0.063") from case for 10s	
Mounting torque	$T_M$	Nm	0.6	M3 screw Maximum of mounting process: 3	



# YJD2120120NCTYG3

## ■Static Electrical Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Gate threshold voltage	V <sub>GS(th)</sub>	V	2.0	3.0	4.0	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 3.7mA	Fig.4, 11
				2.4		V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 3.7mA, T <sub>j</sub> =175°C	
Drain source breakdown voltage	V <sub>(BR)DSS</sub>	V	1200			V <sub>GS</sub> =0V, I <sub>D</sub> =100uA	
Drain source leakage current	I <sub>DSS</sub>	uA		10	100	V <sub>DS</sub> = 1200V, V <sub>GS</sub> =0V	
Gate source leakage current	I <sub>GSS</sub>	nA		10	100	V <sub>GS</sub> = 18V, V <sub>DS</sub> =0V	
Current drain source on-state resistance	R <sub>DS ON</sub>	mΩ		120		V <sub>GS</sub> =15V, I <sub>D</sub> =10A	Fig.5, 6, 7
				115	145	V <sub>GS</sub> =18V, I <sub>D</sub> =10A	
				205		V <sub>GS</sub> =15V, I <sub>D</sub> =10A, T <sub>j</sub> =175°C	
				198		V <sub>GS</sub> =18V, I <sub>D</sub> =10A, T <sub>j</sub> =175°C	
Transconductance	g <sub>f</sub>	S		5		V <sub>DS</sub> =20V, I <sub>D</sub> =10A	Fig.4
				4		V <sub>DS</sub> =20V, I <sub>D</sub> =10A, T <sub>j</sub> =175°C	

## ■Dynamic Electrical Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Input capacitance	C <sub>iss</sub>	pF		1066		V <sub>DS</sub> =1000V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C, f=1MHz, V <sub>AC</sub> = 25mV	Fig.13, 14
Output capacitance	C <sub>oss</sub>		45				
Reverse capacitance	C <sub>rss</sub>		3.6				
Coss stored energy	E <sub>oss</sub>	uJ		32			Fig.15
Gate source charge	Q <sub>gs</sub>	nC		9		V <sub>DS</sub> =1000V, V <sub>GS</sub> =-5/+18V, I <sub>D</sub> =10A	Fig.12
Gate drain charge	Q <sub>gd</sub>		23				
Gate charge	Q <sub>g</sub>		42				
Internal gate resistance	R <sub>g</sub>	Ω		1		f=1MHz	

## ■Switching Characteristics (Tc=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Turn on delay time	t <sub>d(on)</sub>	ns		17		V <sub>DD</sub> =1000V, V <sub>GS</sub> =-5/+18V, I <sub>D</sub> =10A, R <sub>g</sub> =2.4Ω, L=100uH	Fig.21
Rise time	t <sub>r</sub>		15.8				
Turn off delay time	t <sub>d(off)</sub>	ns		16.2			
Fall time	t <sub>f</sub>		27.5				
Turn on switching energy	E <sub>on</sub>	uJ		122		V <sub>DD</sub> =1000V, V <sub>GS</sub> =-5/+18V, I <sub>D</sub> =10A, R <sub>g</sub> =2.4Ω, L=100uH	Fig.19, 20
Turn off switching energy	E <sub>off</sub>		41				



# YJD2120120NCTYG3

## ■Body diode characteristics (T<sub>c</sub>=25°C unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Diode forward voltage	V <sub>SD</sub>	V		4.1		V <sub>GS</sub> =-5V, I <sub>SD</sub> =5A	Fig.8
				2.7		V <sub>GS</sub> =0V, I <sub>SD</sub> =5A, T <sub>j</sub> =175°C	Fig.9
Continuous diode forward current	I <sub>s</sub>	A		20		V <sub>GS</sub> =-5V, T <sub>c</sub> =25°C	
Reverse recovery time	t <sub>rr</sub>	nS		33		V <sub>R</sub> =1000V, V <sub>GS</sub> =-5V, I <sub>b</sub> =10A, di/dt=2000A/uS	
Reverse recovery charge	Q <sub>rr</sub>	nC		120			
Peak reverse recovery current	I <sub>rrm</sub>	A		7			

## ■Thermal Characteristics (T<sub>a</sub>=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Typ.
Thermal resistance	R <sub>θJ-C</sub>	°C/W	1.2

## ■Typical Characteristics

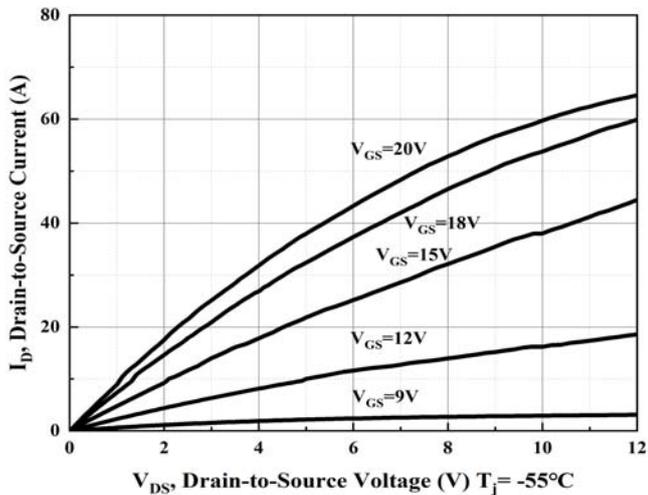


Figure 1. Output Characteristics T<sub>j</sub> = -55°C

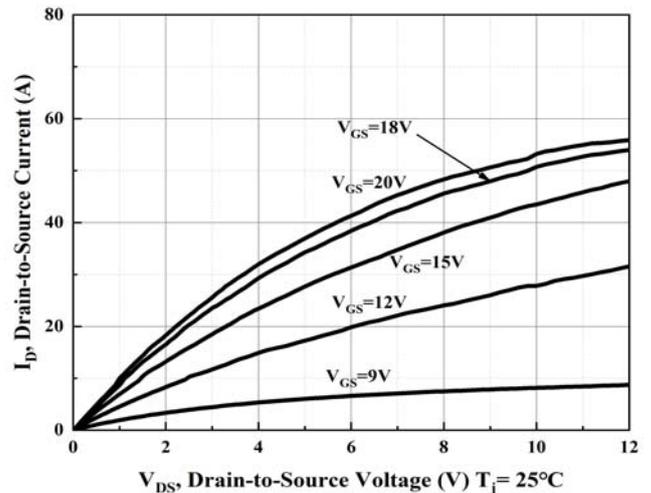


Figure2. Output Characteristics T<sub>j</sub> = 25°C



# YJD2120120NCTYG3

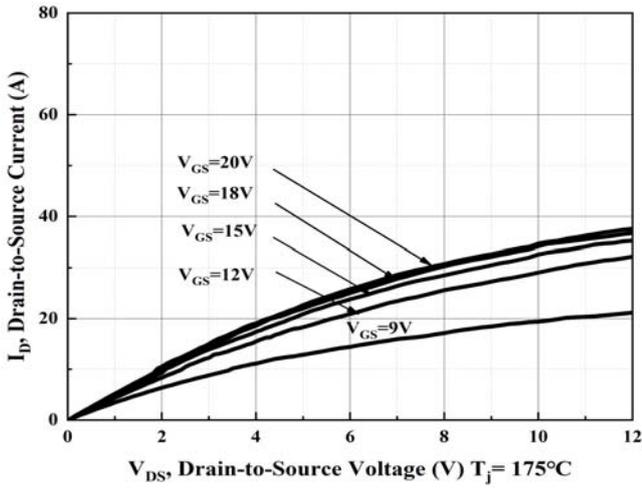


Figure 3. Output Characteristics Tj = 175°C

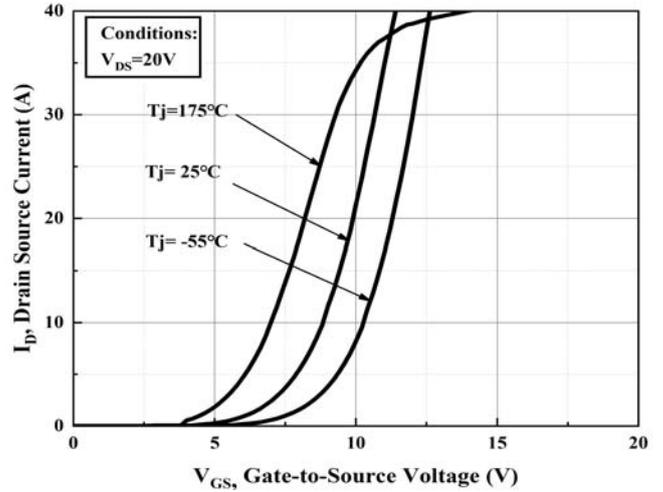


Figure 4. Transfer Characteristics for Various Junction Temperature

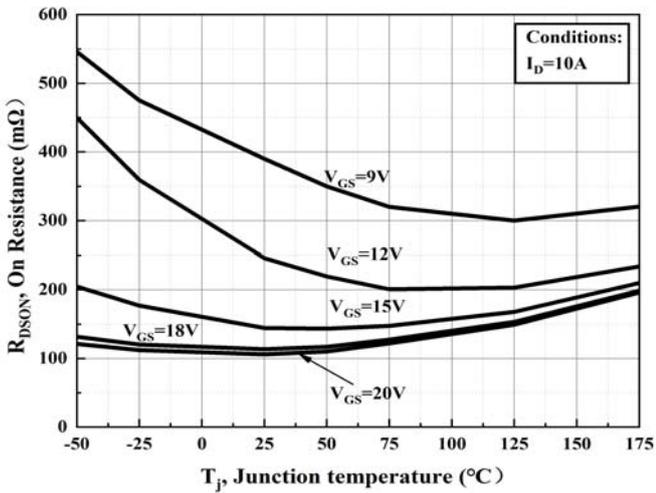


Figure 5. On-resistance vs. Temperature for Various Gate Voltage

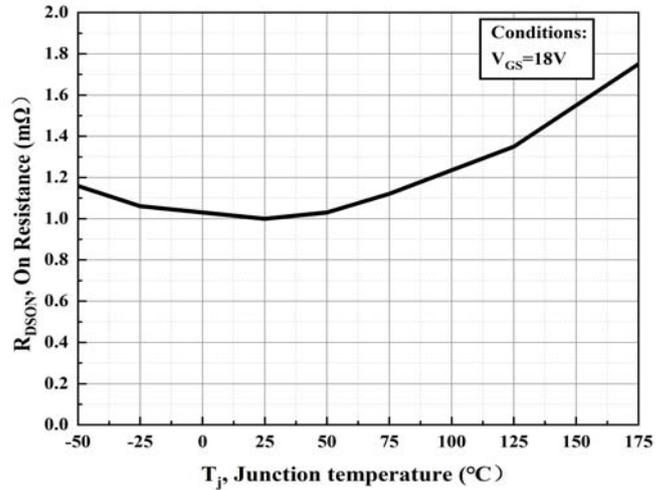


Figure 6. Normalized on-resistance vs. Temperature

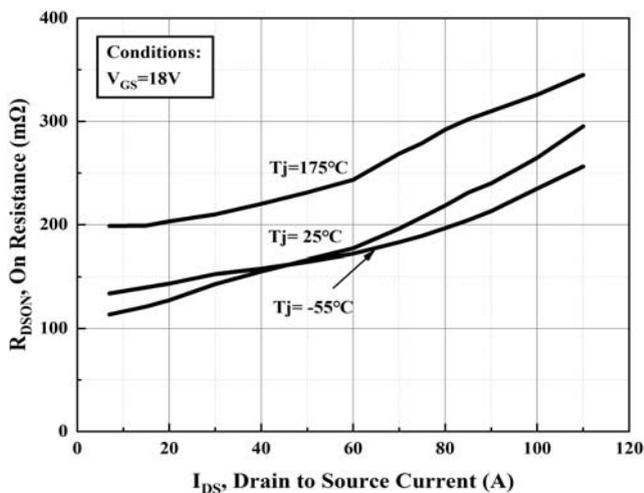


Figure 7. On-resistance vs. Drain Current

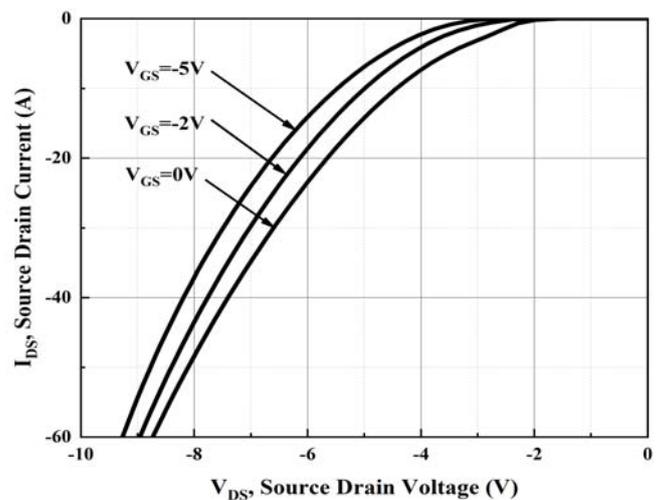


Figure 8. Body Diode Characteristic at Tj = 25 °C



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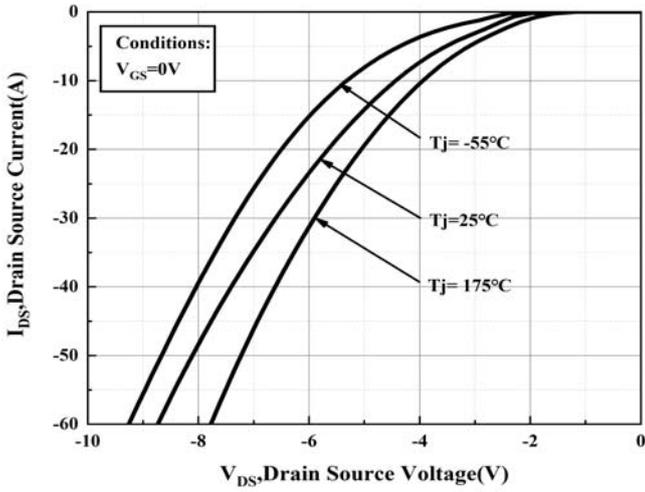


Figure 9. Body Diode Characteristic

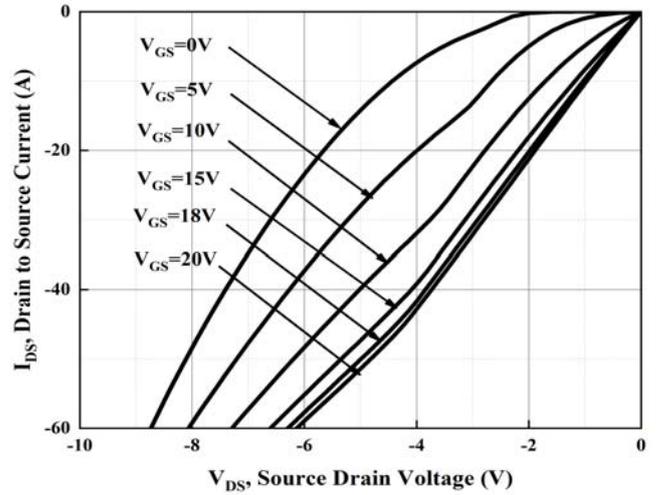


Figure 10. 3<sup>rd</sup> quadrant Characteristic at Tj= 25 °C

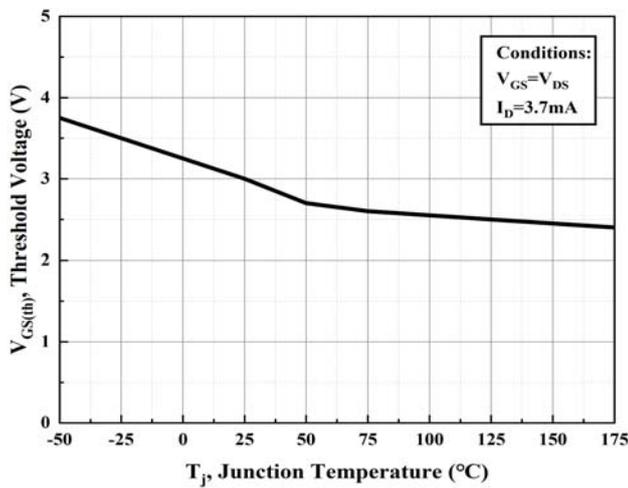


Figure 11. Threshold Voltage vs. Temperature

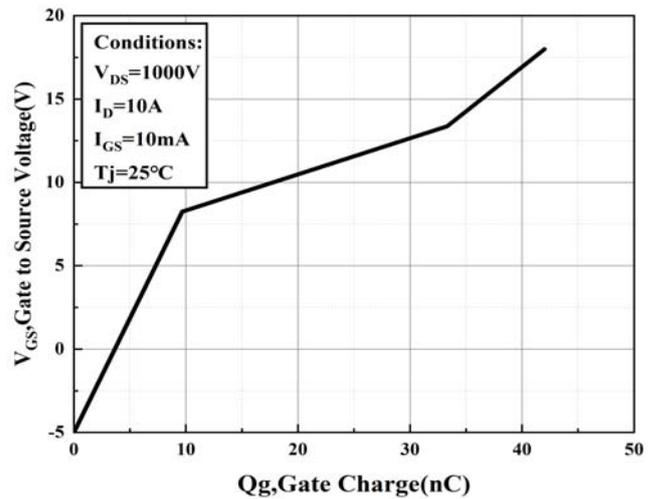


Figure 12. Gate Charge Characteristic

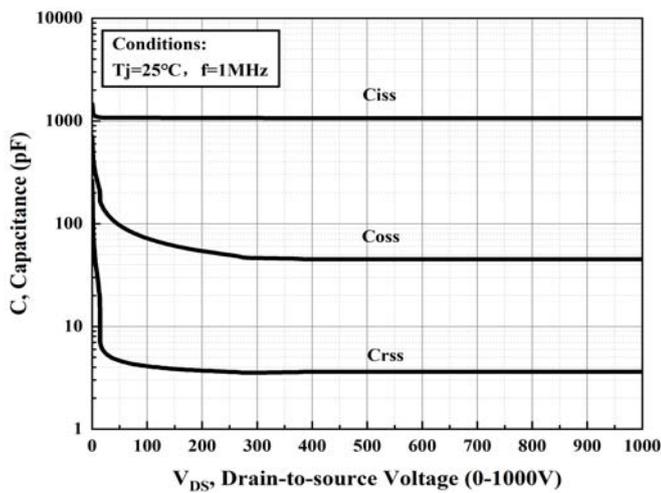


Figure 13. Capacitances vs. Drain Source Voltage (0-1000V)

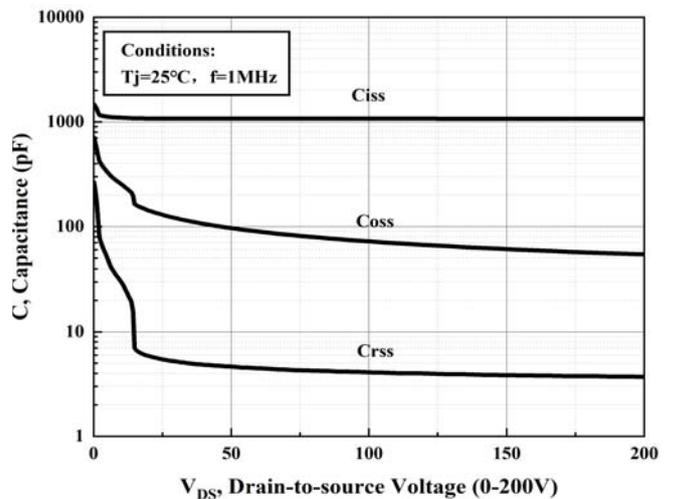


Figure 14. Capacitances vs. Drain Source Voltage (0-200V)



# YJD2120120NCTYG3

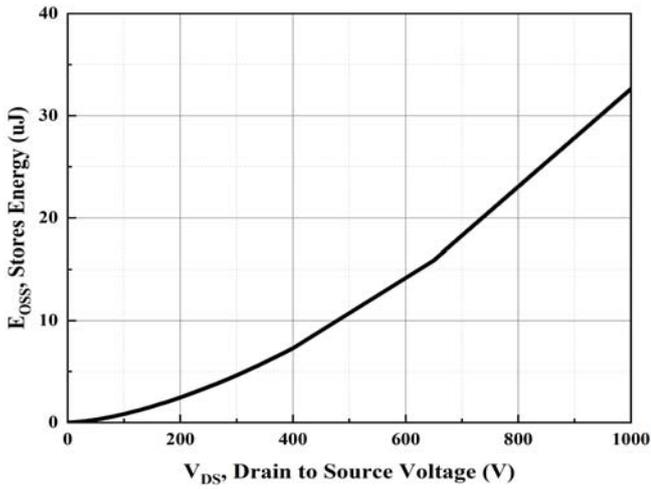


Figure 15. Output Capacitor Stored Energy

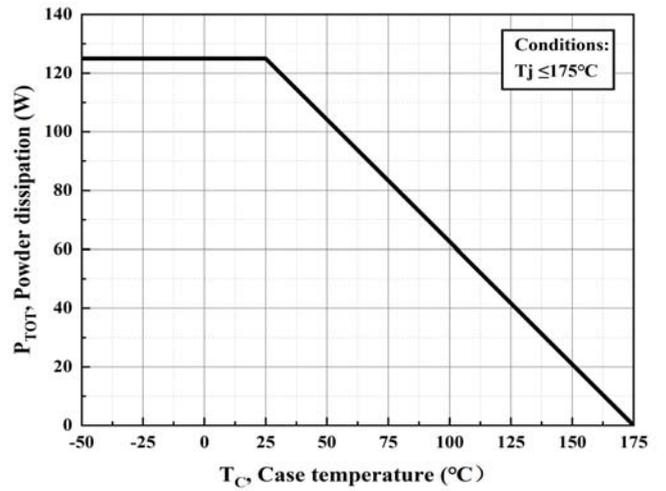


Figure 16. Maximum Power Dissipation Derating vs. Case Temperature

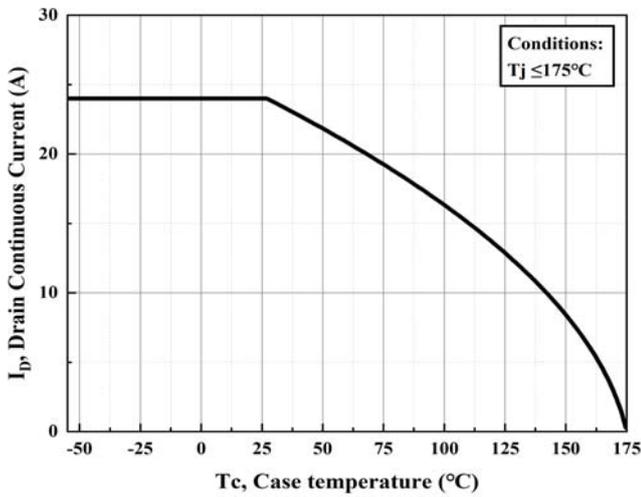


Figure 17. Continuous Drain Current Derating vs. Case Temperature

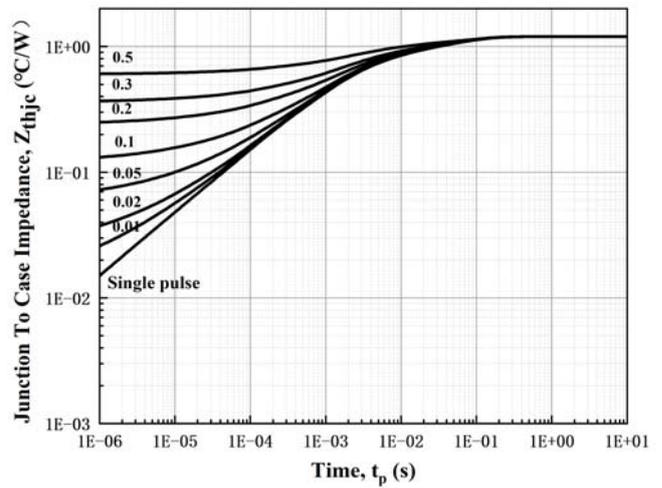


Figure 18. Transient Thermal Impedance (Junction - Case)

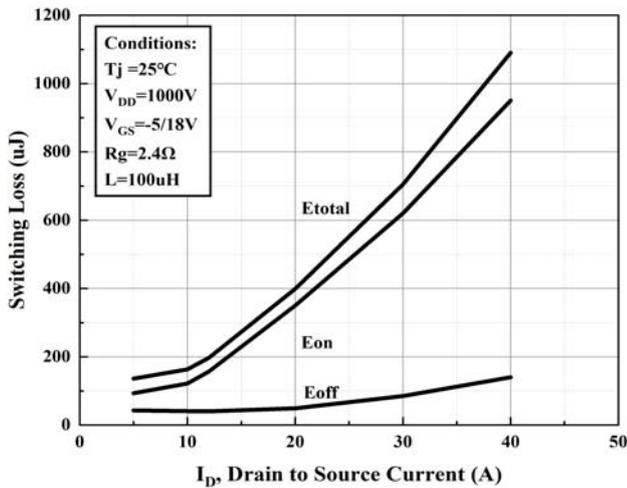


Figure 19. Clamped Inductive Switching Energy vs. Drain Current

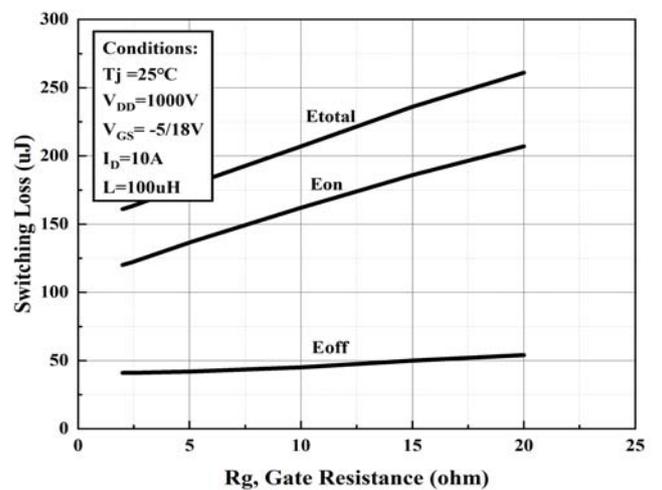


Figure 20. Clamped Inductive Switching Energy vs. Rg

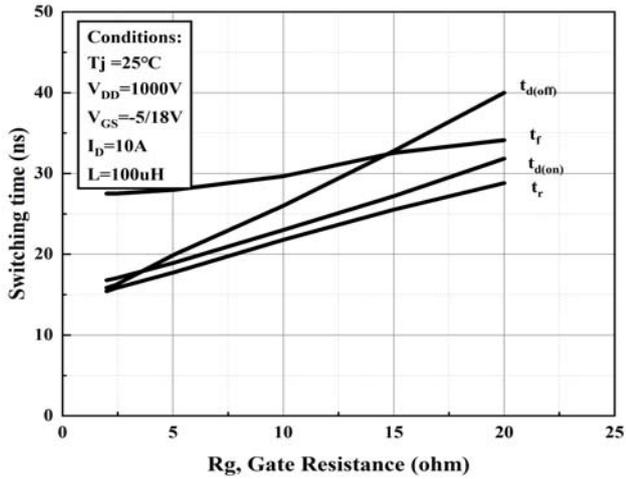


Figure 21. Switching Times vs. Rg

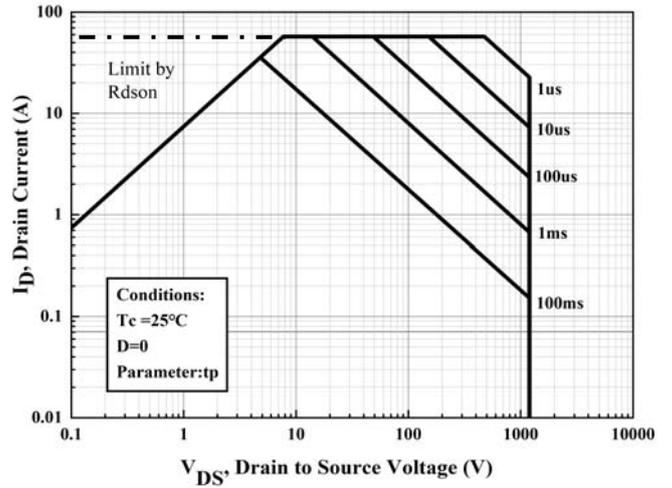


Figure 22. Safe Operating Area

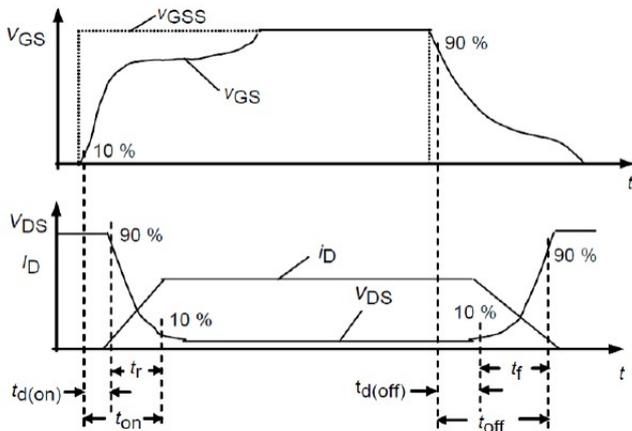


Figure 23. Switching Times Definition

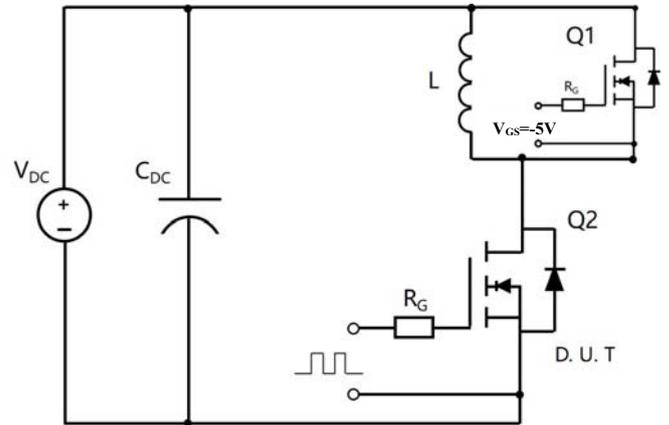


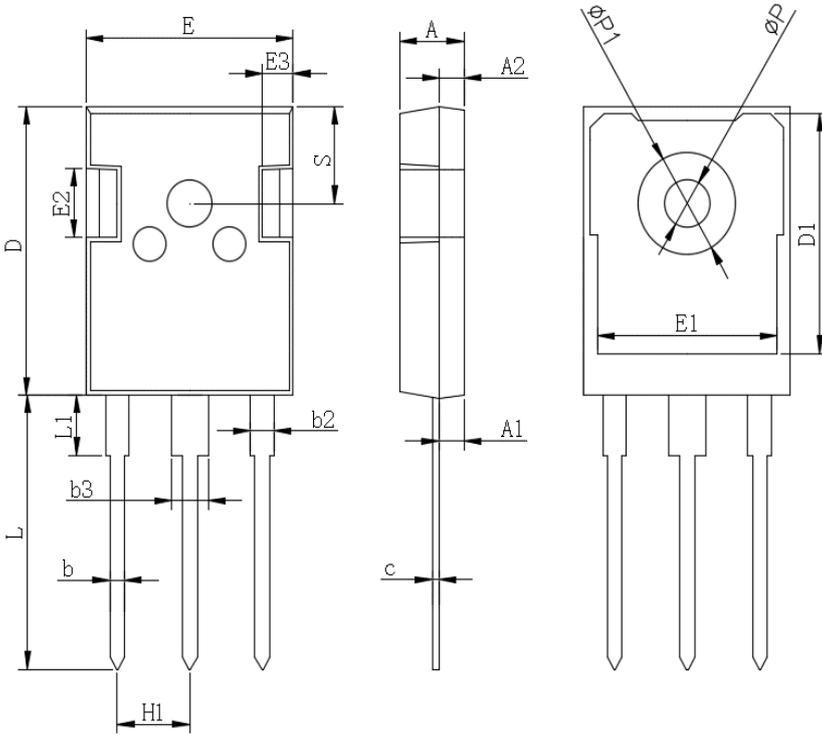
Figure 24. Clamped Inductive Switching Waveform Test Circuit



# YJD2120120NCTYG3

## ■Outline Dimensions

TO-247AB



TO-247AB		
Dim	Min	Max
A	4.80	5.20
A1	2.21	2.61
A2	1.85	2.15
b	1.0	1.4
b2	1.91	2.21
C	0.5	0.7
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.0	13.6
E2	4.80	5.20
E3	2.30	2.70
L	19.62	20.22
L1	-	4.30
$\phi P$	3.40	3.80
$\phi P1$	-	7.30
S	6.15TYP	
H1	5.44TYP	
b3	2.80	3.20



## YJD2120120NCTYG3

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